

200-V half-bridge gate driver IC with V_{CC} & V_{BS} UVLO

Features

- Gate drive supplies up to 20 V per channel
- Undervoltage lockout for V_{CC}, V_{BS}
- 3.3 V, 5 V, 15 V input logic compatible
- Tolerant to negative transient voltage
- Designed for use with bootstrap power supplies
- Cross-conduction prevention logic
- Matched propagation delay for both channels
- Internal set deadtime
- High-side output in phase with HIN input
- Low-side output out of phase with LIN input
- -40°C to 125°C operating range
- 2 kV HBM ESD
- RoHS compliant

Product Summary

| Voffset | ≤ 200 V |
|--|-----------------|
| Vouт | 10 V – 20 V |
| I _{o+} & I _{o-} (typ.) | 290 mA & 600 mA |
| ton & toff (typ.) | 160 ns & 150 ns |
| Deadtime (typ.) | 520 ns |

Description

The IRS2007 is a high voltage, high speed power MOSFET and IGBT driver with dependent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 200 V. Propagation delays are matched to simplify the HVIC's use in high frequency applications.

Package Options



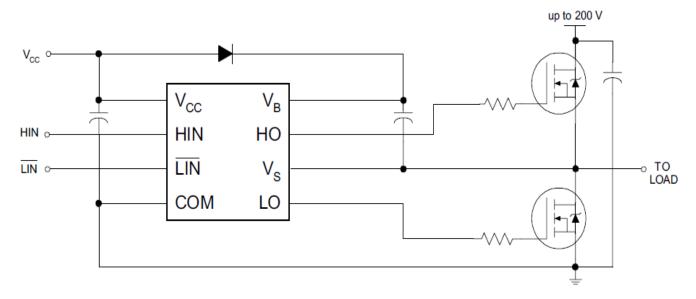
Typical Applications

- Appliance motor drives, Stepper motor, Servo drives
- Micro inverter drives
- General purpose three phase inverters
- Light electric vehicles (e-bikes, e-scooters, e-toys)
- Wireless Charging
- General battery driven applications

| Dana Bard Namel an | B. J T | Standard Pack | | On level to Boot Newston |
|--------------------|-------------------|---------------|----------|--------------------------|
| Base Part Number | Package Type Form | | Quantity | Orderable Part Number |
| | | Tape and Reel | 2500 | IRS2007STRPBF |
| <u>IRS2007S</u> | 8-Lead SOIC | Tube/Bulk | 95 | IRS2007SPBF |
| IRS2007M | 14-Lead MLPQ 4x4 | Tape and Reel | 3000 | IRS2007MTRPBF |



Typical Connection Diagram



(Refer to Lead Assignments for correct pin configuration). This diagram shows electrical connections only. Please refer tour Application Notes & DesignTips for proper circuit board layout.



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol | Definition | Definition | | Max. | Units |
|-------------------|---|-------------------------|---------------------|-----------------------|-------|
| Vcc | Low side supply voltage | | -0.3 | 25 [†] | |
| V _{IN} | Logic input voltage (HIN & LIN) | | COM - 0.3 | V _{CC} + 0.3 | |
| V _B | High-side floating well supply volta | ge | -0.3 | 225 | |
| Vs | High-side floating well supply return | n voltage | V _B - 25 | V _B + 0.3 | V |
| V _{HO} | Floating gate drive output voltage | | Vs - 0.3 | V _B + 0.3 | |
| V _{LO} | Low-side output voltage | Low-side output voltage | | Vcc + 0.3 | |
| COM | Power ground | Power ground | | V _{CC} + 0.3 | |
| dVs/dt | Allowable V _S offset supply transien | t relative to COM | _ | 50 | V/ns |
| D | Package power dissipation @ T _A | 8-Lead SOIC | _ | 0.625 | W |
| P_D | ≤+25°C | 14-Lead MLPQ 4x4 | _ | 2.08 | - vv |
| D#F | Thermal resistance, junction to | 8-Lead SOIC | _ | 200 | 000 |
| Rth _{JA} | ambient | 14-Lead MLPQ 4x4 | _ | 36 | °C/W |
| TJ | Junction temperature | | _ | 150 | |
| Ts | Storage temperature | | -55 | 150 | ∘C |
| T∟ | Lead temperature (soldering, 10 se | econds) | _ | 300 | 1 |

[†] All supplies are tested at 25 V.

Recommended Operating Conditions

For proper operation, the device should be used within the recommended conditions. All voltage parameters are absolute voltages referenced to COM unless otherwise stated in the table. The offset rating is tested with supplies of $(V_{CC} - COM) = (V_B - V_S) = 15V$.

| Symbol | Definition | Min | Max | Units |
|-----------------|--|----------------------|---------------------|-------|
| Vcc | Low-side supply voltage | 10 | 20 | |
| V _{IN} | Logic input voltage | 0 | Vcc | |
| V _B | High-side floating well supply voltage | V _S + 10 | V _S + 20 | |
| Vs | High-side floating well supply offset voltage† | COM - 8 [†] | 200 | V |
| V _{HO} | Floating gate drive output voltage | Vs | V _B | |
| V _{LO} | Low-side output voltage | COM | Vcc | |
| TA | Ambient temperature | -40 | 125 | °C |

⁺ Logic operation for VS of -8 V to 200 V. Logic state held for V_S of -8 V to -V_{BS}. Please refer to Design Tip DT97-3 for more details.



Static Electrical Characteristics

 $(V_{CC} - COM) = (V_B - V_S) = 15V$. $T_A = 25^{\circ}C$ unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to COM. The V_C and I_{IN} parameters are referenced to respective V_S and COM and are applicable to the respective output leads HO or LO. The V_{CCUV} parameters are referenced to COM. The V_{BSUV} parameters are referenced to V_S .

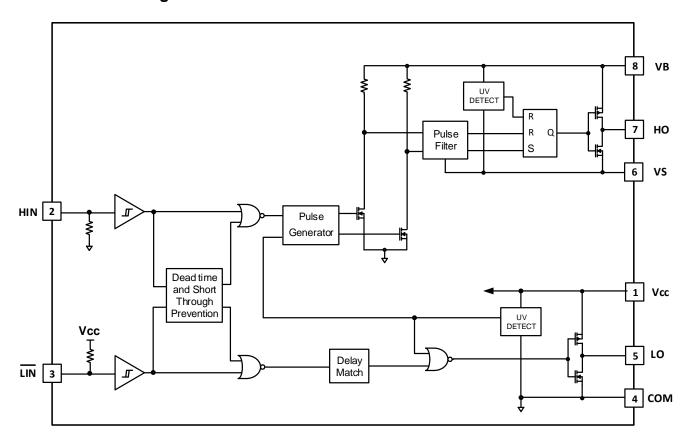
| Symbol | Definition | Min. | Тур. | Max. | Units | Test Conditions |
|---------------------|---|---|------|------|----------------|---|
| V _{BSUV+} | V _{BS} supply undervoltage positive going threshold | 8.0 | 8.9 | 9.8 | | |
| V _{BSUV} - | V _{BS} supply undervoltage negative going threshold | 7.4 | 8.2 | 9 | | |
| V _{BSUVHY} | V _{BS} supply undervoltage hysteresis | _ | 0.7 | _ | V | |
| V_{CCUV^+} | V _{CC} supply undervoltage positive going threshold | 8.0 | 8.9 | 9.8 | V | |
| V _{CCUV} - | V _{CC} supply undervoltage negative going threshold | 7.4 | 8.2 | 9 | | |
| V_{CCUVHY} | V _{CC} supply undervoltage hysteresis | _ | 0.7 | _ | | |
| I_{LK} | High-side floating well offset supply leakage | _ | _ | 50 | | $V_{B} = V_{S} = 200V$ |
| I_{QBS} | Quiescent V _{BS} supply current | _ | 45 | 75 | μΑ | All inputs are in the |
| I _{QCC} | Quiescent V _{CC} supply current | _ | 300 | 520 | | off state |
| V _{OH} | High level output voltage drop, V _{BIAS} -V _O | _ | 0.05 | 0.2 | V | I _O = 2 mA |
| V _{OL} | Low level output voltage drop, Vo | _ | 0.02 | 0.1 | ľ | 10 = 2 IIIA |
| I _{o+} | Output high short circuit pulsed current | 200 | 290 | _ | mA | $V_0 = 0V$, $V_{IN} = V_{IH}$ $PW \le 10\mu s$ |
| l _{o-} | Output low short circuit pulsed current | 420 | 600 | _ | IIIA | $V_0 = 15V$, $V_{IN} = V_{IL}$ $PW \le 10\mu s$ |
| V_{IH} | Logic "1" (HIN) & Logic "0" (LIN) input voltage 2.5 | | _ | _ | V | \/aa_40\/ to 20\/ |
| V_{IL} | Logic "0" (HIN) & Logic "1" (LIN) input voltage | (HIN) & Logic "1" (LIN) input voltage — — 0.8 | | v | Vcc=10V to 20V | |
| I _{IN+} | Logic "1" Input bias current | _ | 3 | 10 | μA | $HIN = 5V, \overline{LIN} = 0V$ |
| I _{IN} - | Logic "0" Input bias current | _ | _ | 5 | μπ | $HIN = 0V, \overline{LIN} = 5V$ |

Dynamic Electrical Characteristics

 $V_{CC} = V_B = 15V$, $V_S = COM$, $T_A = 25^{\circ}C$, and $C_L = 1000$ pF unless otherwise specified.

| Symbol | Definition | Min. | Тур. | Max. | Units | Test Conditions |
|----------------|---|------|------|------|-------|-----------------|
| ton | Turn-on propagation delay | _ | 160 | 220 | | Vs = 0V or 200V |
| toff | Turn-off propagation delay | _ | 150 | 220 | | VS = UV 01 200V |
| t _R | Turn-on rise time | _ | 70 | 170 | | \/- 0\/ |
| t _F | Turn-off fall time | _ | 30 | 90 | | Vs = 0V |
| MT | Delay matching time (t _{ON} , t _{OFF}) | _ | _ | 50 | ns | |
| DT | Deadtime, LS turn-off to HS turn-on & HS turn-on to LS turn-off | 400 | 520 | 650 | | |
| MDT | Deadtime matching time (DT _{LO/HO} – DT _{HO/LO}) | _ | _ | 30 | | |

Functional Block Diagram

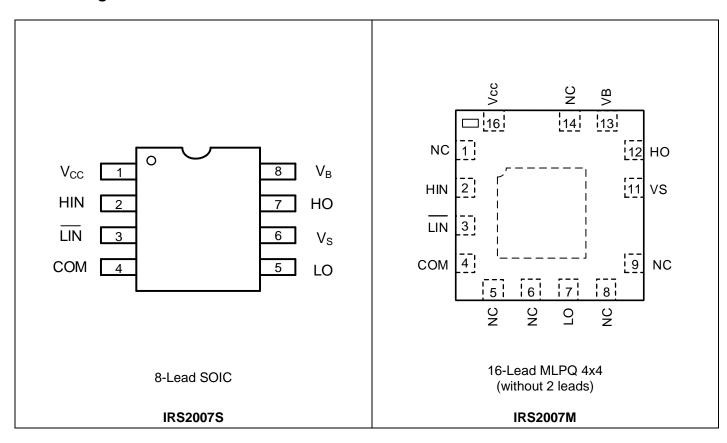




Lead Definitions

| Symbol | Description |
|--------|---|
| Vcc | Low-side and logic supply voltage |
| VB | High-side gate drive floating supply |
| VS | High voltage floating supply return |
| HIN | Logic inputs for high-side gate driver output (HO), in phase |
| LIN | Logic inputs for low-side gate driver output (LO), out of phase |
| НО | High-side driver output |
| LO | Low-side driver output |
| COM | Low-side gate drive return |

Lead Assignments



Application Information and Additional Details

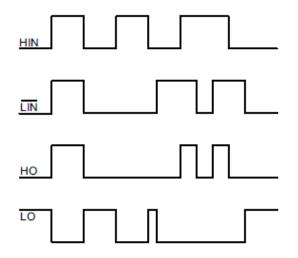
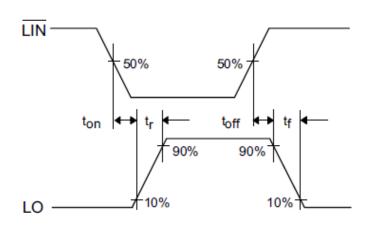


Figure 1. Input/Output Timing Diagram



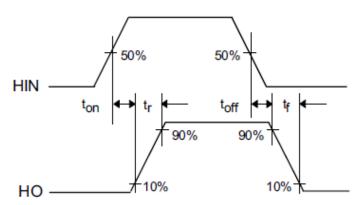


Figure 2. Switching Time Waveform Definitions

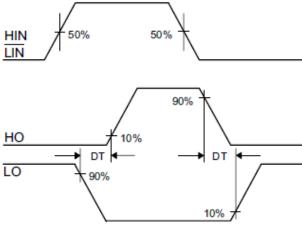


Figure 3. Deadtime Waveform Definitions

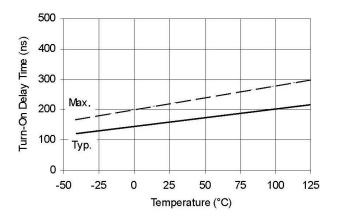


Figure 4A. Turn-On Time vs. Temperature

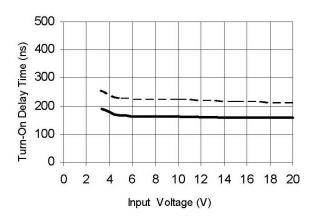


Figure 4C. Turn-On Time vs. Input Voltage

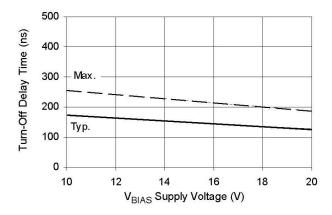


Figure 5B. Turn-Off Time vs. Supply Voltage

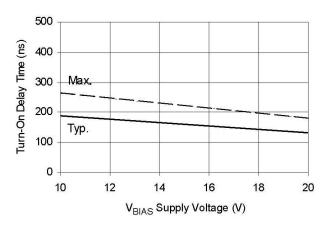


Figure 4B. Turn-On Time vs. Supply Voltage

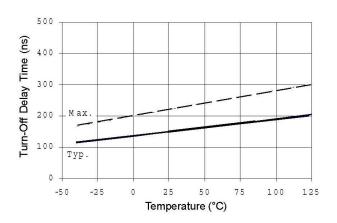


Figure 5A. Turn-Off Time vs. Temperature

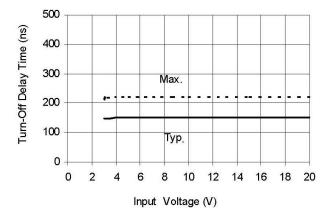


Figure 5C. Turn-Off Time vs. Input Voltage

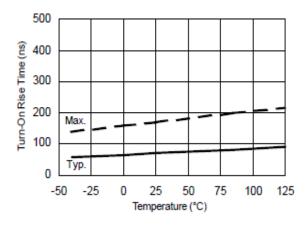


Figure 6A. Turn-On Rise Time vs. Temperature

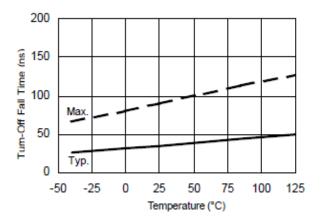


Figure 7A. Turn-Off Fall Time vs. Temperature

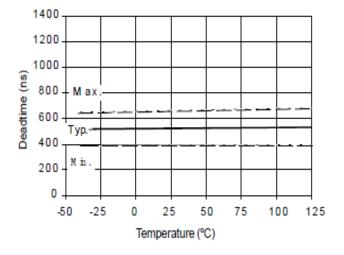


Figure 8A. Deadtime vs. Temperature

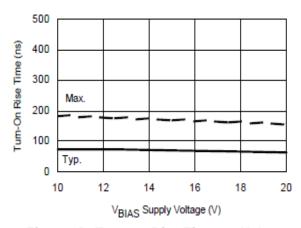


Figure 6B. Turn-On Rise Time vs. Voltage

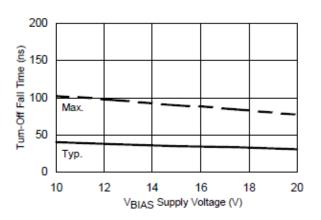


Figure 7B. Turn-Off Fall Time vs. Voltage

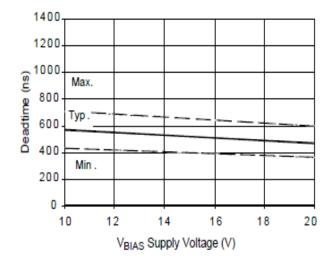
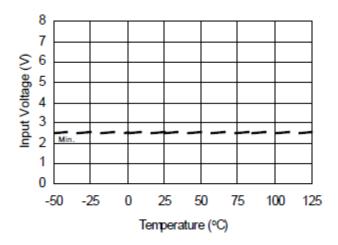


Figure 8A. Deadtime vs. Voltage



8 7 Input Voltage (V) 6 5 4 3 2 1 0 12 14 16 18 20 10 V_{BIAS} Supply Voltage (V)

Figure 9A. Logic "1"(HIN) & Logic "0"(LIN)
Input Voltage vs. Temperature

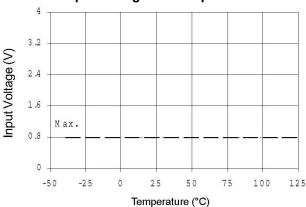


Figure 9B. Logic "1"(HIN) & Logic "0"(LIN)
Input Voltage vs. Voltage

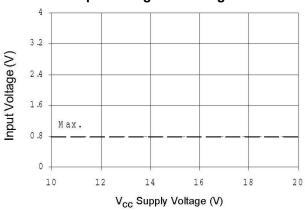


Figure 10A. Logic "0"(HIN) & Logic "1"(LIN)
Input Voltage vs. Temperature

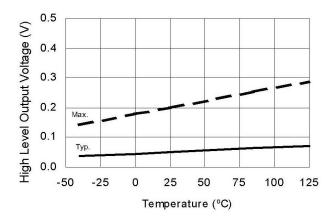


Figure 10B. Logic "0"(HIN) & Logic "1"(LIN)
Input Voltage vs. Voltage

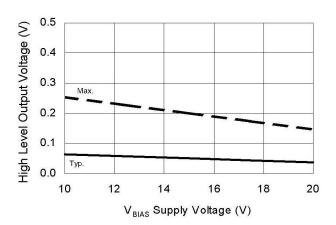


Figure 11A. High Level Output Voltage vs. Temperature

Figure 11B. High Level Output Voltage vs. Supply Voltage

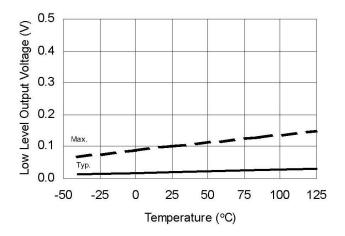


Figure 12A. Low Level Output Voltage vs. Temperature

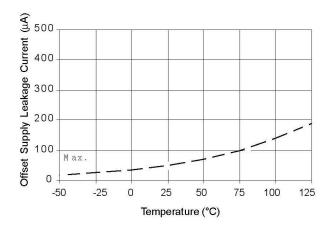


Figure 13A. Offset Supply Current vs. Temperature

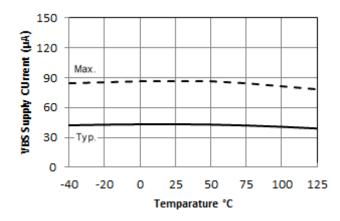


Figure 14A. V_{BS} Supply Current vs. Temperature

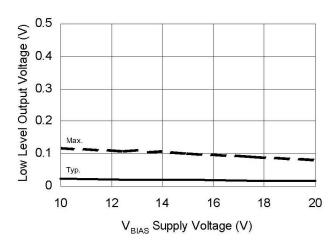


Figure 12B. Low Level Output Voltage vs. Supply Voltage

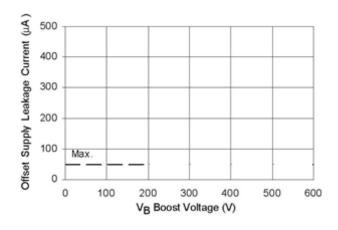


Figure 13B. Offset Supply Current vs. Voltage

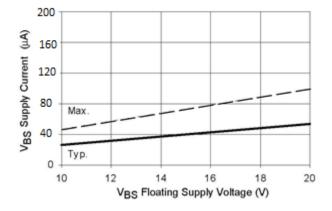


Figure 14B. V_{BS} Supply Current vs. Voltage

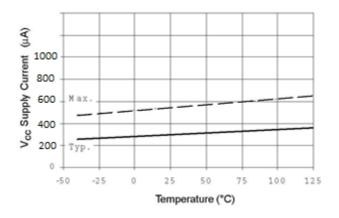


Figure 15A. V_{CC} Supply Current vs. Temperature

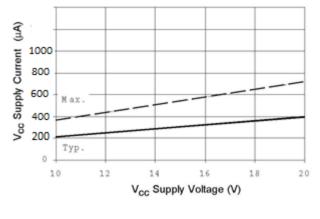


Figure 15B. V_{CC} Supply Current vs. Voltage

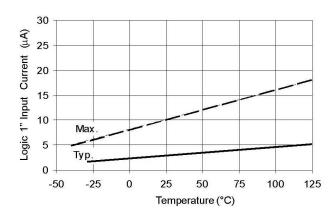


Figure 16A. Logic "1" Input Current vs. Temperature

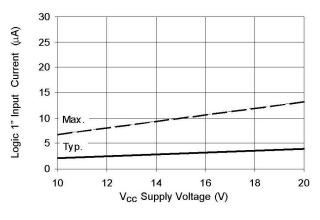


Figure 16B. Logic "1" Input Current vs. Voltage

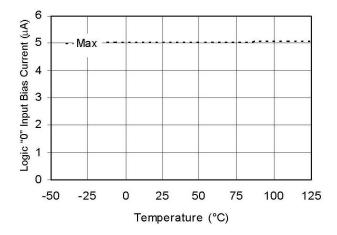


Figure 17A. Logic "0" Input Bias Current

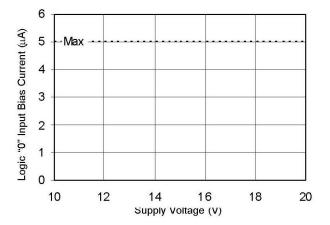


Figure 17B. Logic "0" Input Bias Current

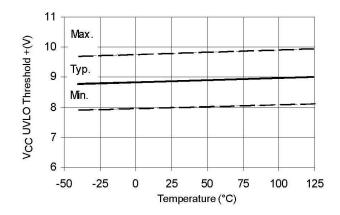


Figure 18A. V_{CC}\V_{BS} Undervoltage Threshold(+) vs. Temperature

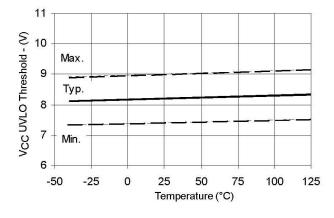


Figure 18B. V_{CC}\V_{BS} Undervoltage Threshold(-) vs. Temperature

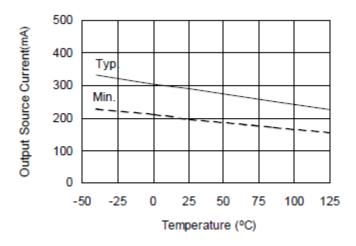


Figure 19A. Output Source Current vs. Temperature

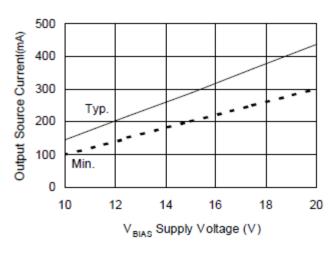


Figure 19B. Output Source Current vs. Supply Current

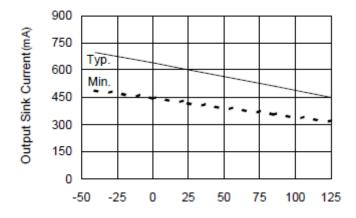


Figure 20A. Output Sink Current vs. Temperature

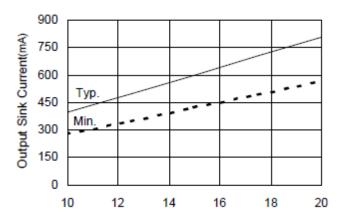
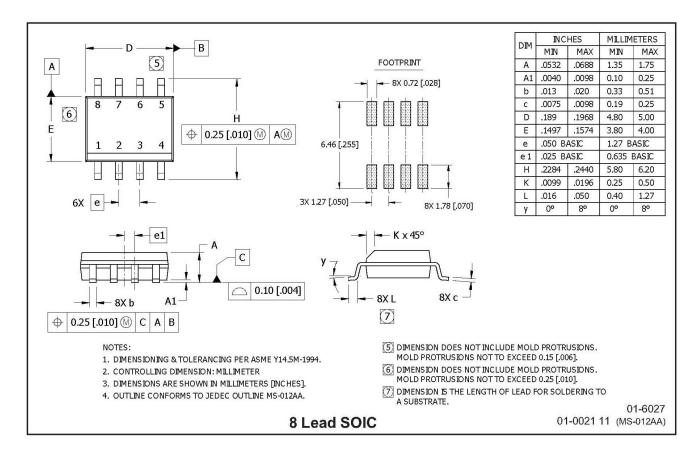


Figure 20B. Output Sink Current vs. Supply Voltage

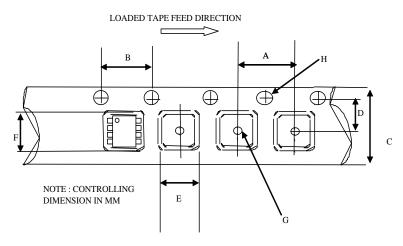


Package Details: 8-Lead SOIC



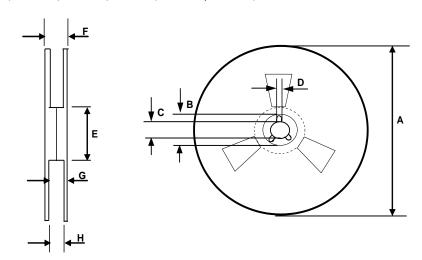


Tape and Reel Details: 8-Lead SOIC



CARRIER TAPE DIMENSION FOR 8SOICN

| | Metric | | Imp | erial |
|------|--------|-------|-------|-------|
| Code | Min | Max | Min | Max |
| Α | 7.90 | 8.10 | 0.311 | 0.318 |
| В | 3.90 | 4.10 | 0.153 | 0.161 |
| С | 11.70 | 12.30 | 0.46 | 0.484 |
| D | 5.45 | 5.55 | 0.214 | 0.218 |
| E | 6.30 | 6.50 | 0.248 | 0.255 |
| F | 5.10 | 5.30 | 0.200 | 0.208 |
| G | 1.50 | n/a | 0.059 | n/a |
| Н | 1.50 | 1.60 | 0.059 | 0.062 |

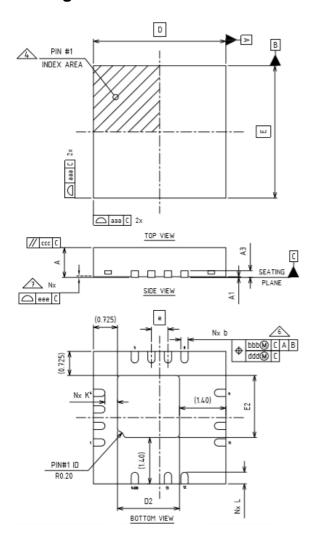


REEL DIMENSIONS FOR 8SOICN

| | Metric | | Imp | erial |
|------|--------|--------|--------|--------|
| Code | Min | Max | Min | Max |
| Α | 329.60 | 330.25 | 12.976 | 13.001 |
| В | 20.95 | 21.45 | 0.824 | 0.844 |
| С | 12.80 | 13.20 | 0.503 | 0.519 |
| D | 1.95 | 2.45 | 0.767 | 0.096 |
| ш | 98.00 | 102.00 | 3.858 | 4.015 |
| F | n/a | 18.40 | n/a | 0.724 |
| G | 14.50 | 17.10 | 0.570 | 0.673 |
| I | 12.40 | 14.40 | 0.488 | 0.566 |



Package Details: 14-Lead MLPQ 4x4



NOTE:

- 1. Dimensioning and tolerancing conform to ASME Y14.5-2009.
- 2. All dimensions are in millimeters.
- 3. N is the total number of terminals.

1. The location of the marked terminal #1 identifier is within the hatched area.

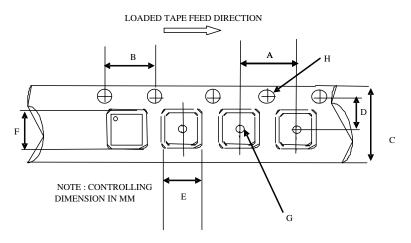
5. ND and NE refer to the number of terminals on each D and E side respectively.

Olimension b applies to the metalized terminal and is measured between 0.15mm and 0.30mm from the terminal tip. If the terminal has a radius on the other end of it, dimension b should not be measured in that radius area.

Coplanarity applies to the terminals and all other bottom surface metalization.

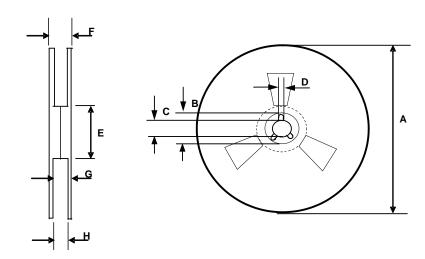
| Dimension Table | | | | | |
|---------------------|------------|----------|---------|------|--|
| Thickness Symbol | V | | | NOTE | |
| mbol | MINIMUM | NOMINAL | MAXIMUM | | |
| A | 0.80 | 0.90 | 1.00 | | |
| A1 | 0.00 | 0.02 | 0.05 | | |
| A3 | | 0.20 Ref | | | |
| Ь | 0.18 | 0.25 | 0.30 | 6 | |
| D | | 4.00 BSC | | | |
| E | | 4.00 BSC | | | |
| е | | 0.50 BSC | | | |
| D2 | 1.725 | 1.875 | 1.975 | | |
| E2 | 1.725 | 1.875 | 1.975 | | |
| K | 0.20 | | | | |
| L | 0.25 | 0.35 | 0.45 | | |
| aaa | | 0.05 | | | |
| bbb | | 0.10 | | | |
| CCC | | 0.10 | | | |
| ddd | 0.05 | | | | |
| eee | 0.08 | | | | |
| N | 14 | | | 3 | |
| ND | SEE FIGURE | | | 5 | |
| NE | | | | , | |
| NOTES | | 1, 2 | | | |

Tape and Reel Details: 14-Lead MLPQ 4x4



CARRIER TAPE DIMENSION FOR MLPQ4x4

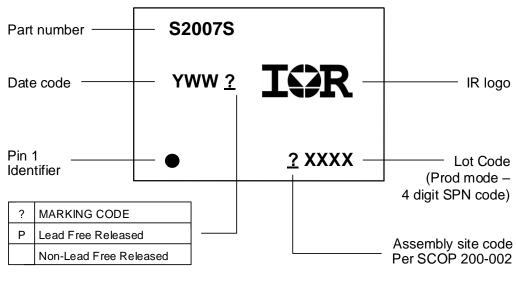
| <u> </u> | | OF IT IT IT I E BIME I TOTO I TOTO IN ET QUET | | | | | |
|----------|--------|---|-------|--------|--|--|--|
| | Metric | | lm | perial | | | |
| Code | Min | Max | Min | Max | | | |
| Α | 7.90 | 8.10 | 0.311 | 0.358 | | | |
| В | 3.90 | 4.10 | 0.153 | 0.161 | | | |
| С | 11.70 | 12.30 | 0.461 | 0.484 | | | |
| D | 5.45 | 5.55 | 0.215 | 0.219 | | | |
| E | 4.25 | 4.45 | 0.168 | 0.176 | | | |
| F | 4.25 | 4.45 | 0.168 | 0.176 | | | |
| G | 1.50 | n/a | 0.069 | n/a | | | |
| Н | 1.50 | 1.60 | 0.069 | 0.063 | | | |



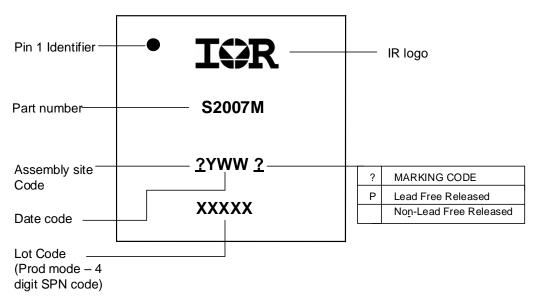
REEL DIMENSIONS FOR MLPQ4x4

| | Metric | | lm | perial |
|------|--------|--------|--------|--------|
| Code | Min | Max | Min | Max |
| Α | 329.60 | 330.25 | 12.976 | 13.001 |
| В | 20.95 | 21.45 | 0.824 | 0.844 |
| С | 12.80 | 13.20 | 0.503 | 0.519 |
| D | 1.95 | 2.45 | 0.767 | 0.096 |
| Е | 98.00 | 102.00 | 3.858 | 4.015 |
| F | n/a | 18.40 | n/a | 0.724 |
| G | 14.50 | 17.10 | 0.570 | 0.673 |
| Н | 12.40 | 14.40 | 0.488 | 0.566 |

Part Marking Information



8-Lead SOIC8 IRS2007SPBF



14-Lead MLPQ 4x4 IRS2007MPBF



Qualification Information[†]

| Qualification Level | | Industrial† Comments: This family of ICs is qualified according to relevant tests of JEDEC47/22/20. IR's Consumer qualification level is granted by extension of the higher Industrial level. | | |
|---------------------|------------------|--|-------------------------|----------------------------|
| | | | | Moisture Sensitivity Level |
| 14-Lead MLPQ 4x4 | | | | |
| ESD | Human Body Model | Class 2 (per JEDEC standard JESD22-A114) | | |
| | Machine Model | Class A (per EIA/JEDEC standard EIA/JESD22-A115) | | |
| IC Latch-Up Test | | | Class I (per JESD78) | |
| RoHS Compliant | | Yes | | |

According to IR Qualification Requirements for IC products.

[†] †† Higher MSL ratings may be available for the specific package types listed here. Please contact your Infineon sales representative for further information.



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